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Name of conveying parties:	Name and address of receiving party:				
 PARK, Ik-Seong LEE, Jin-Won IN, Chi-Ok KIM, Sun-Hong CHOI, Hwa-Kyung 	Name: ALTI-ELECTRONICS CO., LTD. Address: 90-1, Bongmyeong-ri, Namsa-myeon, Cheoin-gu City: Yongin-si State: Gyeonggi-do ZIP: 449-882 Contry: Republic of Korea				
Additional name(s) of conveying party(ies) attached?	Additional name(s) of receiving party(ies) attached?				
() Yes (X) No	() Yes (X) No O				
 3. Nature of conveyance: (X) Assignment () Security Agreement () Merger () Change of Name () Other: 	4. US or PCT Application number(s) or US Patent				
Execution Date:	4. US or PCT Application number(s) or US Patent properties number(s):				
1) May 16, 2006 2) May 16, 2006	(X) Application(s) filed herewith				
3) May 16, 2006 4) May 16, 2006	Additional numbers attached?				
5) May 16, 2006	() Yes (X) No				
Party to whom correspondence concerning document should be mailed:	Total number of applications and patents involved: 1				
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ASSIGNMENT

WHEREAS, I/WE (1) PARK, Ik-Seong, a Republic of Korea citizen, residing at #108-2304 Dongah APT., Bongcheon 2-dong, Gwanak-gu, Seoul 151-052, Republic of Korea, (2) LEE, Jin-Won, a Republic of Korea citizen, residing at #107-501, Perien APT., Yeiwon maeul, Gorim-dong, Yongin-si, Gyeonggi-do 449-010, Republic of Korea, (3) IN, Chi-Ok, a Republic of Korea citizen, residing at 919, Geumcheon-ri, Sinpyeong-myeon, Dangjin-gun, Chungcheongnam-do 343-812, Republic of Korea, (4) KIM, Sun-Hong, a Republic of Korea citizen, residing at 25-88, Juan 5-dong, Nam-gu, Incheon 402-205, Republic of Korea, (5) CHOI, Hwa-Kyung, a Republic of Korea citizen, residing at San 90-1, Bongmyeong-ri, Namsa-myeon, Yongin-si, Gyeonggi-do 449-882, Republic of Korea

hereinafter referred to as Assignor (collectively if more than one inventor is listed above), have invented certain new and useful improvements in <u>Light Emitting Diode (LED) package</u>, the specification of which:

(a)	•	was executed on even date herewith;	•
(b)	0	was filed onas Application No	_or o Express
		Mail No., as Application No. not yet known and	was amended on
		(if applicable); or	
(c)	o	was described and claimed in PCT International Application Noand as amended under PCT Article 19 on	filed on (if any) and/or
		under PCT Article 34 on (if any).	(it unly) und of

AND WHEREAS, <u>ALTI-ELECTRONICS CO., LTD.</u> with its principal place of business at <u>90-1</u>, <u>Bongmyeong-ri, Namsa-myeon, Cheoin-gu, Yongin-si, Gyeonggi-do 449-882, Republic of Korea</u>, (hereinafter referred to as Assignee) desires to acquire the entire right, title, and interest in and to the said improvements with respect to the United States of America, its territories and possessions.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Assignor hereby acknowledges that it has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto Assignee, its successors, legal representatives and assigns, the entire right, title, and interest in the United States of America, and its territories and possessions in, to and under said improvements, and any Patent Applications in the United States of America and all divisions, renewals and continuations thereof, and all Patents of the United States of America which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions; and Assignor hereby authorizes and requests the Commissioner of Patents of the United States of America to issue all Patents for said improvements to Assignee, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND ASSIGNOR HEREBY covenants and agrees that it will communicate to Assignee, its successors, legal representatives and assigns, any facts known to it respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in the United States of America.

PATENT REEL: 018064 FRAME: 0170

NY WHEREC	F, Assignor	intending to be legally bound has hereunto affixed its signature.
May	_, 20 <u>0</u> 6}	Signature of PARK, Ik-Seong
May	, 20 06	Signature of LEE, Jin-Won
May	_, 20 <u>06</u>	Signature of IN, Chi-Ok
May	_, 20 <i>26</i>	Signature of KIM, Sun-Hong
May	_, 20 <u>06</u>	Signature of CHOI, Hwa-Kyung
	May May May	May , 2006

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RECORDED: 06/28/2006

PATENT REEL: 018064 FRAME: 0171